

SB20200 SCHOTTKY RECTIFIER

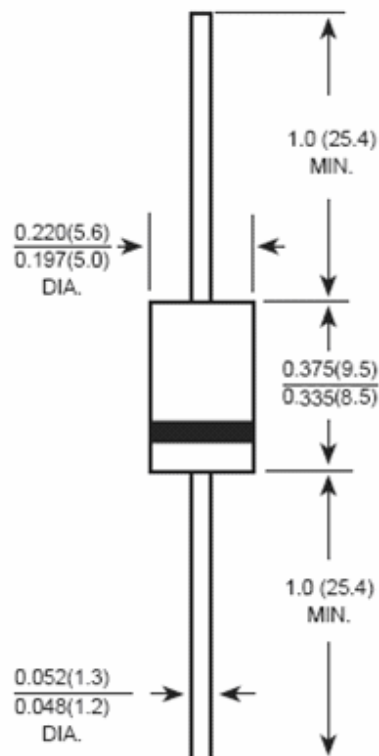
Applications:

- Disk Drives
- Switching power supply
- Converters
- Free-Wheeling diodes
- Reverse battery protection
- Battery Charging

Features:

- Small foot print, surface moutable
- Low forward voltage drop
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- This is a Pb – Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

Mechanical Dimensions: In Inches / mm



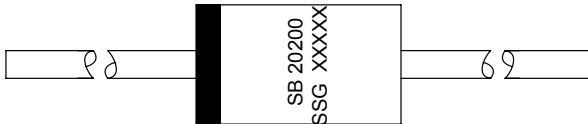
DO-201AD



Technical Data
Data Sheet N0889, Rev. -

Green Products

Marking Diagram:



Where XXXXX is YYWWL

SB	= Device Type
20	= Forward Current (20A)
200	= Reverse Voltage (200V)
SSG	= SSG
YY	= Year
WW	= Week
L	= Lot Number

Cautions : Molding resin
Epoxy resin UL:94V-0

Ordering Information:

Device	Package	Shipping
SB20200	DO-201AD (Pb-Free)	1250pcs / tape

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification.



Maximum Ratings and Electrical Characteristics @ $T_A=25^{\circ}\text{C}$ unless otherwise specified

Single Phase, half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

Characteristic	Symbol	SB20200	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	200	V
Maximum RMS Voltage	V_{RMS}	140	V
Average Rectified Output Current (Note 1) @ $T_C = 135^{\circ}\text{C}$	$I_{F(AV)}$	20	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	I_{FSM}	300	A
Forward Voltage @ $I_F = 20\text{A}, T_A = 25^{\circ}\text{C}$ @ $I_F = 20\text{A}, T_A = 125^{\circ}\text{C}$	V_{FM}	1.10 1.00	V
Peak Reverse Current At Rated DC Blocking Voltage @ $T_A = 25^{\circ}\text{C}$ @ $T_A = 125^{\circ}\text{C}$	I_{RM}	1 8	mA
Typical Thermal Resistance Junction to Case	$R_{\theta JC}$	2	$^{\circ}\text{C}/\text{W}$
Storage Temperature Range	T_J, T_{STG}	-50 to +150	$^{\circ}\text{C}$
Approximate Weight	wt	1.02	g
Case Style	DO-201AD		

Note:1. Mount on Cu-Pad Size 5mm×5mm on P.C.B.



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